

OLED PRODUCT SPECIFICATION

Manufactured by:



| PART NUMBER: | USMP-P23302 |
|--------------|---|
| DESCRIPTION: | 0.8", 96 x 32, Monochrome White, TAB, SSD0300 IC |

| ISSUE DATE | APPROVED BY | CHECKED BY | PREPARED BY |
|----------------------|--|------------|-------------------------|
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REVISION RECORD

| REV. | REVISION DESCRIPTION | REV. DATE | REMARK |
|------|----------------------|--------------|--------|
| X01 | INITIAL RELEASE | 2009. 02. 09 | |





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1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Assembly Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications, which are either not addressed, or are exceptions to the supporting documents.

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored or used as the conditions specified in the specifications. Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.

After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

Small molecular organic light emitting diode.

Color: White

Panel matrix: 96*32 Driver IC: SSD1307

Excellent Quick response time: 10µs

Extremely thin thickness for best mechanism design: 1.41 mm

High contrast : 2000:1 Wide viewing angle : 160°

SPI (Serial Peripheral Interface), I²C Interface.

Strong environmental resistance.

Wide range of operating temperature: -40 to 70°C

Anti-glare polarizer.

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4. MECHANICAL DATA

| NO | ITEM | SPECIFICATION | UNIT |
|----|-------------------|--------------------------------|-----------------|
| 1 | Dot Matrix | 96 (W) x 32 (H) | dot |
| 2 | Dot Size | 0.18 (W) x 0.18 (H) | mm ² |
| 3 | Dot Pitch | 0.20 (W) x 0.20 (H) | mm ² |
| 4 | Aperture Rate | 81 | % |
| 5 | Active Area | 19.18 (W) x 6.38 (H) | mm ² |
| 6 | Panel Size | 28.5 (W) x 11.5 (H) | mm ² |
| 7 | Panel Thickness | 1.41 ± 0.1 | mm |
| 8 | Module Size | 49.4 (W) x 11.8 (H) x 1.41 (D) | mm ³ |
| 9 | Diagonal A/A size | 0.8 | inch |
| 10 | Module Weight | 0.95 ± 10% | gram |





5. MAXIMUM RATINGS

| ITEM | MIN | MAX | UNIT | Condition | Remark |
|-----------------------------------|--------|-----|------|--|-------------------|
| Supply Voltage (V _{DD}) | -0.3 | +4 | V | Ta = 25 °C | IC maximum rating |
| Supply Voltage (Vcc) | 7 | 16 | V | Ta = 25 °C | IC maximum rating |
| Operating Temp. | -40 | 70 | °C | | |
| Storage Temp | -40 | 85 | °C | | |
| Humidity | | 85 | % | | |
| Life Time | 21,000 | - | Hrs | 140 cd/m ² , 50% checkerboard | Note (1) |
| Life Time | 25,000 | - | Hrs | 120 cd/m ² , 50% checkerboard | Note (2) |
| Life Time | 30,000 | - | Hrs | 100 cd/m ² , 50% checkerboard | Note (3) |

Note:

(A) Under VCC = 12, Ta = 25°C, 50% RH.

(B) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

(1) Setting of 140 cd/m²:

Contrast setting: 0x40

Frame rate: 105Hz Duty setting: 1/32

(2) Setting of 120 cd/m²:

Contrast setting: 0x36

Frame rate: 105Hz

Duty setting: 1/32

(3) Setting of 100 cd/m²:

Contrast setting: 0x2C

Frame rate: 105Hz

Duty setting: 1/32

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6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

| SYMBOL | PARAMETERS | TEST CONDITION | MIN | TYP | MAX | UNIT |
|------------------|--|----------------------|----------------------|-----|----------------------|------|
| V _{CC} | Analog power supply (for OLED panel) | Ta=-20 °C to +70°C | 11.5 | 12 | 12.5 | V |
| V_{DD} | Digital power supply | Ta=-20 °C to +70°C | 1.65 | 2.8 | 3.3 | V |
| I _{DD} | Operating current for V _{DD} VDD = 2.8V, VCC = 12V, IREF = 10uA No Panel attached, All Display ON | Contrast=FF | - | 23 | 30 | uA |
| lcc | Operating current for V _{CC} VDD = 2.8V, VCC = 12V, IREF = 10uA No panel attached, All Display ON | Contrast=FF | - | 455 | 590 | uA |
| V _{IH} | High logic input level | | 0.8* V _{DD} | - | - | V |
| V_{IL} | Low logic input level | | - | - | 0.2* V _{DD} | V |
| V_{OH} | High logic output level | louт = 100uA, 3.3MHz | $0.9^* V_{DD}$ | - | - | V |
| V_{OL} | Low logic output level | IOUT = 100uA, 3.3MHz | - | - | $0.1^* V_{DD}$ | V |
| | Segment on output current | Contrast=FF | 285 | 316 | 345 | uA |
| | V _{DD} =2.8V, V _{CC} =12V, | Contrast=AF | - | 217 | - | uA |
| I _{SEG} | IREF=10uA, Display on, | Contrast=7F | - | 158 | - | uA |
| | | Contrast=3F | - | 78 | - | uA |
| | | Contrast=0F | - | 19 | - | uA |

Note: The Vcc input must keep in a stable value; ripple and noise are not allowed.

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6.2 ELECTRO-OPTICAL CHARACTERISTICS

PANEL ELECTRICAL SPECIFICATIONS

| PARAMETER | MIN | TYP. | MAX | UNITS | COMMENTS |
|--------------------------------|--------|------|------|-------------------|-----------------------------------|
| Normal mode current | | 5 | 6 | mA | All pixels on (1) |
| Standby mode current | | 1 | 1.5 | mA | Standby mode 10% pixels on (2) |
| Normal mode power consumption | | 60 | 72 | mW | All pixels on (1) |
| Standby mode power consumption | | 12 | 18 | mW | Standby mode 10% pixels on (2) |
| Normal mode Luminance | 100 | 120 | | cd/m ² | Display Average |
| Standby mode Luminance | | 20 | | cd/m ² | |
| CIEx (White) | 0.24 | 0.28 | 0.32 | | v v (CIE 1021) |
| CIEy (White) | 0.28 | 0.32 | 0.36 | | x, y (CIE 1931) |
| Dark Room Contrast | 2000:1 | - | - | | |
| Viewing Angle | 160 | | | degree | |
| Response Time | | 10 | | μs | |

(1) Normal mode condition:

Driving Voltage: 12

Contrast setting: 0x36

Frame rate: 105Hz Duty setting: 1/32

(2) Standby mode condition:

Driving Voltage: 12

Contrast setting: 0x00

Frame rate: 105Hz

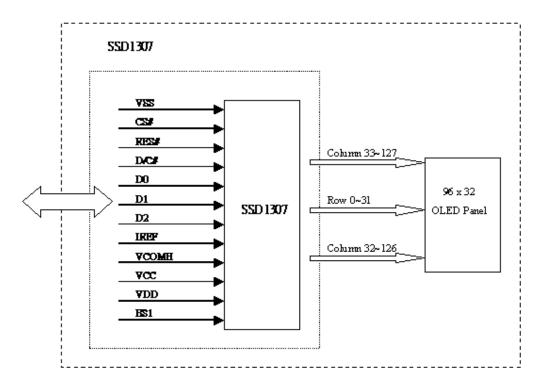
Duty setting: 1/32





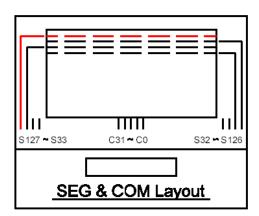
7. INTERFACE

7.1 FUNCTION BLOCK DIAGRAM



RiTdisplay 96X32 OLED Module

7.2 PANEL LAYOUT DIAGRAM



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7.3 PIN ASSIGNMENTS

| Pin No. | Pin Name | Description |
|---------|----------|--|
| 1 | VSS | This is a ground pin. |
| 2 | CS# | This pin is the chip select input. |
| 3 | RES# | Hardware reset signal |
| 4 | D/C# | In 4-wire Serial mode, this is Data/Command control pin. In I ² C mode, this pin acts as SA0 for slave address selection. |
| 5 | D0 | 4-wire SPI: SCLK I ² C: SCL |
| 6 | D1 | 4-wire SPI: SDIN I ² C: SDAIN |
| 7 | D2 | 4-wire SPI: NC I ² C: SDAOUT |
| 8 | IREF | The current reference input pin, this pin should be connected to ground through a resistor. |
| 9 | VCOMH | The COM voltage reference pin, this pin should be connected to ground through a capacitor. |
| 10 | VCC | Positive OLED high voltage power supply |
| 11 | VDD | Power supply for logic circuit |
| 12 | BS1 | MCU Bus Interface Pin Selection 0: 4-wire Serial Interface 1: I ² C Interface |

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7.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 128 x 39 bits and the RAM is divided into five pages, from PAGE0 to PAGE4, which are used for monochrome 128x39 dot matrix display, as shown in below figures.

When one data byte is written into GDDRAM, all the rows image data of the same page of the current column are filled (i.e. the whole column (8 bits) pointed by the column address pointer is filled.). Data bit D0 is written into the top row, while data bit D7 is written into bottom row. For PAGE4, bit D7 is treated as don't care bit.

For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. For vertical shifting of the display, an internal register storing the display start line can be set to control the portion of the RAM data to be mapped to the display (command D3h).

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GDDRAM pages structure of SSD1307

| Page Data 8 8 8 8 8 8 8 8 8 | mapping | ment re- J (command A1h) | SEG127 | SEG126 | SEG125 | SEG124 | | SEG4 | SEG3 | SEG2 | SEG1 | SEGO | | |
|--|---------|--|--------|--------|--------|--------|----------------|--------|--------|--------|--------|--------|---------------------------|--|
| Page Data 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 8 | mapping | (command | SEG0 | SEG1 | SEG2 | SEGS | | SEG123 | SEG124 | SEG125 | SEG126 | SEG127 | | |
| D1 | Page | Data | COLO | ∞L1 | 200 | യവ | | COL123 | 00L124 | 00L125 | ∞L126 | ∞L127 | Direction (command C0h | COM Output Scan Direction (command C8h) |
| 0 D3 | | | | | | | | | | | | | COM0 | COM38 |
| 0 D3 D4 COM3 COM35 COM35 D5 COM6 COM33 COM6 COM33 D6 COM6 COM31 COM7 COM7 COM31 COM7 COM7 COM7 COM7 COM7 COM7 COM7 COM7 | | | | 9 | 0.00 | | | | 8 | | | | | |
| Data | | | | 2 | | | | ¢ 02 | S | | | 2 | | |
| D4 | 0 | D3 | | X. | | | 90099096 | 0 1 | 3 | | | | | |
| D6 | · · | | | | | | | | | | | | | |
| D7 | | | | | 1 | | | | , A | | | | | |
| D0 | | | | y 69 | \$ - N | | | | | | | 9 49 | | |
| D1 | | | | 9 | | | | ((i) | | | | | | |
| 1 D2 | | D0 | | | | | | | | | | | | |
| 1 D3 | | D1 | | | | | | | | | | | COM9 | COM29 |
| D4 | | | | | | | | | | | | | | |
| D4 COM12 COM26 D5 COM13 COM25 D6 COM15 COM23 D7 COM15 COM23 D8 COM16 COM22 D9 COM17 COM21 D1 COM18 COM20 D1 COM19 COM19 D2 COM19 COM19 D6 COM22 COM16 D7 COM20 COM18 D6 COM22 COM16 D7 COM21 COM17 D8 COM22 COM16 D9 COM20 COM18 D1 COM20 COM19 COM20 COM19 COM20 COM19 COM21 COM19 COM22 COM16 COM25 COM13 COM26 COM12 COM27 COM11 D4 COM28 COM10 D5 COM29 COM8 D7 COM30 COM8 D7 COM31 COM7 D8 COM32 COM6 D9 COM32 COM6 D1 COM32 COM6 D1 COM32 COM6 D1 COM32 COM6 D2 COM33 COM5 D3 COM35 COM3 D4 COM36 COM3 | 1 | D3 | | 2 9 | | Î | | 5 - 95 | 6 | | | 8 | COM11 | COM27 |
| D6 | | - | | | | | | Ç 33 | | | | | COM12 | COM26 |
| D7 | | D5 | | | | | | | | | | | COM13 | COM25 |
| D0 | | | | | | • | | | | | | | | |
| Each box represents one bit of image data | 7 | | | | | | | | | | | | | |
| D2 | | D0 | | | | | | 1 8 | \$ - T | | | | COM16 | COM22 |
| 2 D3 COM19 COM19 D4 COM20 COM18 D5 COM21 COM17 D6 COM22 COM16 D7 COM23 COM15 COM23 COM15 COM23 COM15 COM25 COM14 D1 COM25 COM14 COM14 D1 COM25 COM12 COM26 COM12 COM26 COM12 COM27 COM11 D2 COM27 COM11 COM27 COM10 D5 COM29 COM9 D6 COM30 COM8 D7 COM30 COM8 D7 COM31 COM7 COM31 COM7 D0 COM31 COM7 COM31 COM7 D0 COM32 COM6 D1 COM32 COM6 D1 COM35 COM3 COM3 D4 COM35 COM3 D4 COM35 COM3 D4 COM35 COM3 D4 COM36 COM2 D5 COM37 COM1 | | | | 9 | ů, | | Each box repre | sen | ts o | ne l | bit | | | |
| D4 | | | | | | | of image data | | | | | | | |
| COM20 COM18 | 2 | D3 | | | | | | 3 | 8 | | | | | |
| D6 | | | | 31 | 99 | | | | | | | 7 | | |
| D7 | | | | | | | | | | | | | | |
| D0 | | | | | | | | 7 7 | | | | | | |
| COM25 COM13 | | 17 (117) | | | X. | | | Î | | | | | 1692,10 M 164 (0 100 K) | |
| D2 | | | | | | | | | | | | | | |
| 3 D3 COM27 COM11 D4 COM28 COM10 D5 COM29 COM9 D6 COM30 COM8 D7 COM31 COM7 D0 COM32 COM6 D1 COM32 COM6 D1 COM34 COM5 D2 COM34 COM4 D3 COM35 COM3 D4 COM35 COM3 D4 COM36 COM2 D5 COM37 COM1 | | | | 2 | 33 | | | 8 9 | | | | | | |
| D4 | | 2 D3 D4 D5 D6 D7 D0 D1 D2 D2 | | | | | | | | | | | | |
| COM28 COM10 | 3 | | | - 7 | St 50 | | 50,07509 | | | | | | | |
| D6 | | | | | ľ j | | | | | | | | | |
| D7 COM31 COM7 D0 COM32 COM6 COM32 COM6 COM32 COM6 COM33 COM5 COM34 COM4 COM4 D3 COM35 COM3 COM35 COM3 COM36 COM2 COM37 COM1 | I | | | | | | of image data | | | | | | | |
| D0 | | | | | 15 2 | | | | | | | | | |
| D1 | | A CONTRACTOR OF THE PROPERTY O | | | | | | | 9 | | | | | A Company of the Comp |
| D2 | 10. | | | | | | | | T Y | | | | | |
| 4 D3 COM35 COM3 D4 COM36 COM2 D5 COM37 COM1 | I | | | | | | | | | | \Box | | | |
| D4 COM36 COM2 D5 COM37 COM1 | I | | | | | | | | | | | | | |
| D5 COM37 COM1 | 4 | | | y 5 | | | | 4 0 | | | | | | |
| | I | | | | | | | | | | | | | |
| D6 COM0 | I | | | | | | | 3 9 | 1 | | | | | |
| D7 Don't care bit | | D6 | | | | | 44000 | | | | | | COM38 | COM0 |

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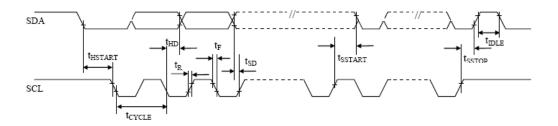




7.5 INTERFACE TIMING CHART

I²C Interface Timing Characteristics

| Symbol | Parameter | Min | Тур | Max | Unit |
|---------------------|---|-----|-----|-----|------|
| t _{cycle} | Clock Cycle Time | 2.5 | - | - | us |
| t _{HSTART} | Start condition Hold Time | 0.6 | - | - | us |
| t _{HD} | Data Hold Time (for "SDA _{OUT} " pin) | 0 | - | - | ns |
| | Data Hold Time (for "SDA _{IN} " pin) | 300 | - | - | ns |
| t _{SD} | Data Setup Time | 100 | - | - | ns |
| t _{SSTART} | Start condition Setup Time (Only relevant for a repeated Start condition) | 0.6 | - | - | us |
| t _{SSTOP} | Stop condition Setup Time | 0.6 | - | - | us |
| t _R | Rise Time for data and clock pin | - | - | 300 | ns |
| t _F | Fall Time for data and clock pin | - | - | 300 | ns |
| t _{IDLE} | Idle Time before a new transmission can start | 1.3 | - | - | us |



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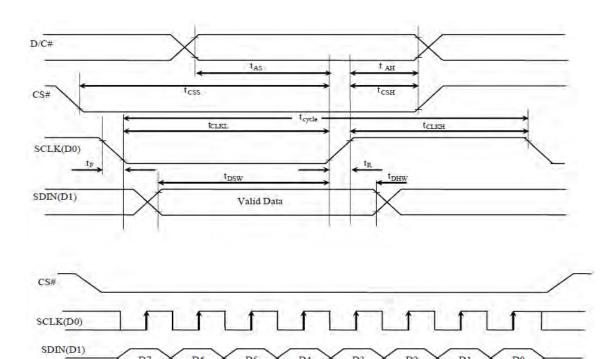
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Serial Interface Timing Characteristics (4-wire SPI)

| Symbol | Parameter | Min | Тур | Max | Unit |
|--------------------|------------------------|--------|------|-------|------|
| t _{cycle} | Clock Cycle Time | 100 | 201 | ¥. — | ns |
| tas | Address Setup Time | 15 | 8 | 4.7 | ns |
| t _{AH} | Address Hold Time | 15 | | ÷ | ns |
| tcss | Chip Select Setup Time | 20 | F1 | 7 | ns |
| tcsn | Chip Select Hold Time | 10 | (-11 | 411 | ns |
| t _{DSW} | Write Data Setup Time | 15 | 200 | - | ns |
| t _{DHW} | Write Data Hold Time | 15 | | ¥1. T | ns |
| tclkl | Clock Low Time | 20 | + | - | ns |
| t _{CLKH} | Clock High Time | 20 | - | 7 | ns |
| t _R | Rise Time | | (-c | 40 | ns |
| t _F | Fall Time | 21/622 | è | 40 | ns |
| | | | | | |



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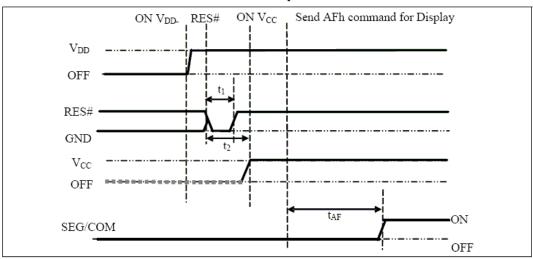
8. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

8.1 POWER ON / OFF SEQUENCE

Power ON sequence:

- 1. Power ON VDD
- 2. After V_{DD} become stable, set RES# pin LOW (logic low) for at least 3us (t₁) ⁽³⁾ and then HIGH (logic high).
- 3. After set RES# pin LOW (logic low), wait for at least 3us (t2). Then Power ON Vcc. (1)
- 4. After Vcc become stable, send command AFh for display ON. SEG/COM will be ON after 100ms (tap).

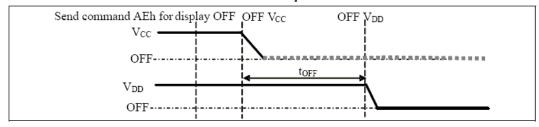
The Power ON sequence



Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Power OFF Vcc (1), (2)
- 3. Power OFF V_{DD} after t_{OFF}. (where Minimum t_{OFF}=80ms, Typical t_{OFF}=100ms)

The Power OFF sequence



Note:

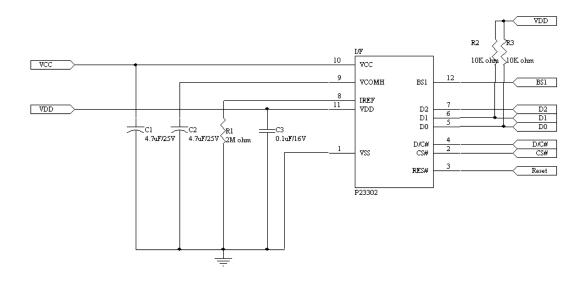
- (1)V_{CC} should be disabled when it is OFF.
- ⁽²⁾ Power Pins (V_{DD} , V_{CC}) can never be pulled to ground under any circumstance.
- (3) The register values are reset after t₁.
- (4) V_{DD} should not be Power OFF before V_{CC} Power OFF.

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8.2 APPLICATION CIRCUIT



Component:

C1 \ C2: 4.7uF/16V(0805)

C3: 0.1uF/16V(0603)

R1: 2M ohm 1%(0603)

R2 · R3: 10K ohm (0603)

This circuit is for I²C Interface

8.3 COMMAND TABLE

Refer to SSD1307 IC Spec.





9. RELIABILITY TEST CONDITIONS

| No. | Items | Specification | Quantity |
|-----|--|---|----------|
| 1 | High temp. (Non-operation) | 85°C, 240hrs | 5 |
| 2 | High temp. (Operation) | 70°C, 120hrs | 5 |
| 3 | Low temp. (Operation) | -40°C, 120hrs | 5 |
| 4 | High temp. / High humidity (Operation) | 65°C, 90%RH, 120hrs | 5 |
| 5 | Thermal shock (Non-operation) | -40°C ~85°C (-40°C /30min; transit /3min; 85°C /30min; transit /3min) 1cycle: 66min, 100 cycles | 5 |
| 6 | Vibration | Frequency: 5~50HZ, 0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X, Y, Z | 1 Carton |
| 7 | Drop | Height: 120cm Sequence: 1 angle · 3 edges and 6 faces Cycles: 1 | 1 Carton |
| 8 | ESD (Non-operation) | Air discharge model, ±8kV, 10 times | 5 |

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

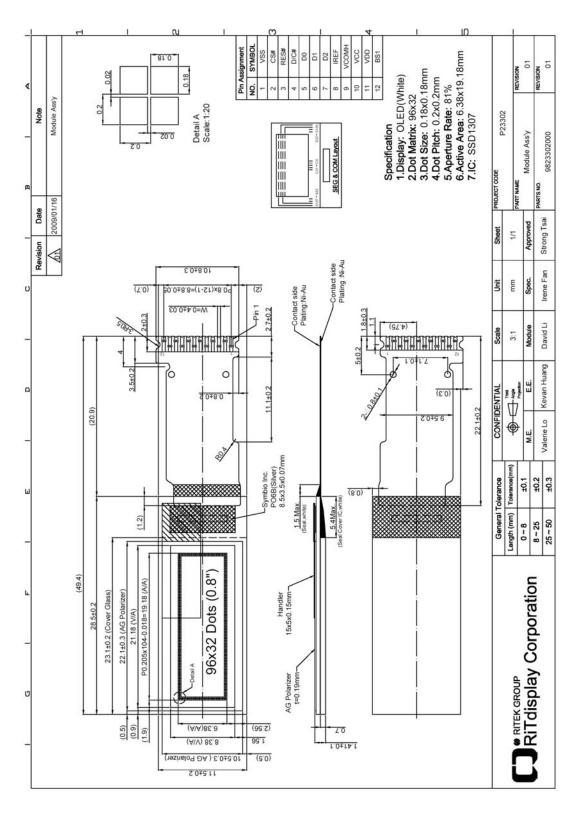
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10. EXTERNAL DIMENSION



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11. PACKING SPECIFICATION

TBD





12. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

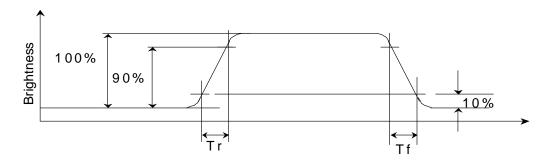


Figure 2 Response time

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D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.

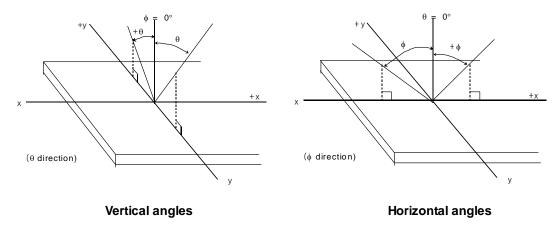


Figure 3 Viewing Angle

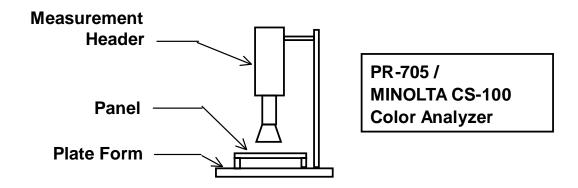




APPENDIX 2: MEASUREMENT APPARATUS

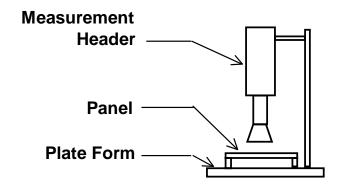
A. LUMINANCE/COLOR COORDINATE

PHOTO RESEARCH PR-705, MINOLTA CS-100



B. CONTRAST / RESPONSE TIME / VIEWING ANGLE

WESTAR CORPORATION FPM-510



Westar FPM-510 **Display Contrast /** Response time / View angle Analyzer

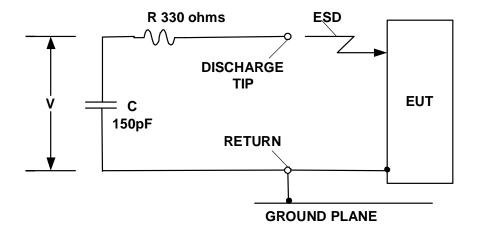
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C. ESD ON AIR DISCHARGE MODE







APPENDIX 3: PRECAUTIONS

A. RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

Displays

US Micro Products is an industrial distributor specializing in engineered display solutions. We dedicate ourselves to providing the best in displays for the medical, industrial, gaming, automotive, aerospace, military and consumer markets.

OLEDs



Passive LCDs



TFT Display



Multitouch



Open Frame Monitors



Touch Screen



As our customer, you receive expert knowledge, support and service. Our technical sales staff and experienced design engineers provide answers to your questions and engineered solutions to meet your display needs.

Peripheral Devices

Our full line of peripheral devices includes keyboards, trackballs and printers. These rugged industrial products are designed to meet the rigorous demands of your equipment and are available in a variety of standard and custom options.

Keyboards



Trackballs



Aerospace Trackballs



Printers



